

### **About Geehy**



#### **Geehy Semiconductor**

- Founded in 2019, the wholly-owned subsidiary of Apexmic, formerly known as IoT Chip Division of Apexmic
- Has inherited 20 years of experience in IC chip design from Apexmic
- Main products: APM32 MCU, Security SoC and BLE SoC
- Four chip R&D centers: Zhuhai/Shanghai/Hangzhou/ USA
- Four central offices: Zhuhai/Shanghai/Shenzhen/Guangzhou



#### **Parent company: Apexmic Microelectronics**

- Full range of printer chip design companies from printer master SoC chip to consumables encryption chip
- Based on the largest Security SoC supplier with domestic CPU shipments (currently more than 500 million in total)
- Annual chip shipments are about 450 million

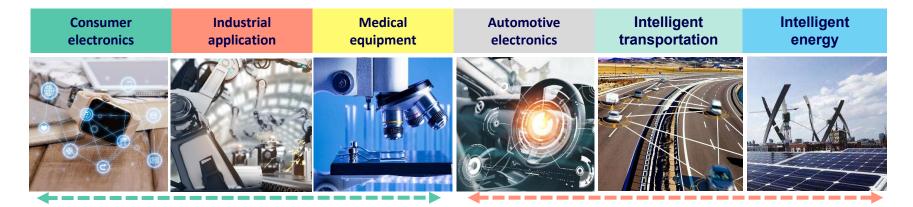
#### Head office: Ninestar Corporaton (SZSE002180)

- Leading company in the global general consumables industry
- 2020 China's Top 500 Listed Companies
- One of the top five global laser printer manufacturers
- 2019 revenue of about 23.3 billion yuan, profits of about 7.4 billion yuan, 1.3 billion yuan chip revenue

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### **Application Field**





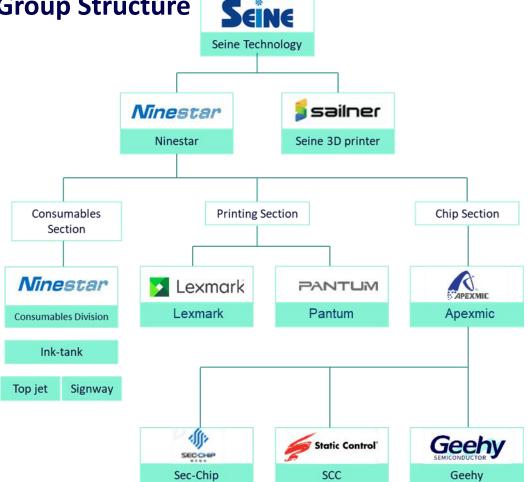
By 2019, Geehy has widely applied in the fields of industrial application, consumer and medical electronics

By 2020, Geehy has officially started the deployment of the fields of automotive electronics, intelligent transportation, and intelligent energy

Future, Geehy will continue to focus on iterative updating technology and product research and innovation, is committed to providing more self-controlled, safe, and reliable chip products and solutions.

# **Group Structure**





In the past 20 years, Ninestar's chip business has been engaged in the research and development of security SoC for a long time, firmly occupying a leading position in the global market of compatible consumables encryption chips, and successfully launched printers with independent intellectual property rights. At present, it is making every effort to enter industrial Internet security SoC.

### **Development Roadmap**



**• Ninestar** 

2000

**Establish** Ninestar

R&D printing consumables security SoC

2001

**Establish Apexmic** 

2004

**APEXMIC** 

CSKY

2011

Establish strategic cooperation with C-Sky Microsystems Successfully listed on Shenzhen stock exchange (SZSE:002180)

2014

2020

2015 2016 Acquisition SCC and Acquisition Lexmark SEC-CHIP technology Lexmark Static Control chip

Obtain the permanent authorization of ARM three CPUs, and release the first MCU; Undertake power grid project; wholly acquire Sec-

2018



Establish Geehy:

2019

Mass production of MCU: First industrial Internet Security Communication Chip network test



Won the China Henggin Sci.&Tech entrepreneurship competition first prize: **Established Apex** Semiconductors (USA) Co.,Ltd.





# **Group Global Layout**





Netherlands

18000 employees in 60 countries

9 R &D centers: Zhuhai, Shenzhen, Shanghai, Hangzhou, USA (North Carolina, Lexington, Kansas), India, Philippines

Factories: China, Mexico, Philippines, Poland, USA

Office: Zhuhai, Shanghai, Shenzhen, Guangzhou



Hang Zhou

- Related companies
- Associated factory
- R & amp; D Center
- Sales network



### Four Chip Research And Development Centers



#### **♦** Apexmic-Zhuhai

R & D headquarters, responsible for product definition, system simulation test, and terminal product application software development; be responsible for chip system software design

#### **♦** Static Control Components

Over 30 years experience in chip design, responsible for chip simulation, digital/analog hybrid integrated circuit design, failure analysis, and IP design



### Zhuhai



### Shanghai

◆ Apexmic-Shanghai Analog IP, ASIC and NFC chip design, Digital and analog hybrid circuit, Memory circuit integrated design

#### USA



#### Hangzhou

#### **♦** Sec-Chip Technology

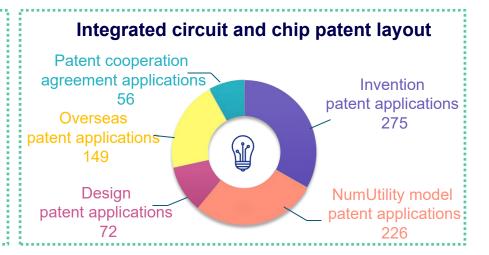
- IC design team based on doctor and master
- First echelon of domestic kernel design
- 8/16/32-bit CPU and DSP independent design
- Design of high-performance multi-core heterogeneous SoC chips
- Encryption and decryption IP design and coprocessor design
- MCU and SoC design

More than 500 people chip design team

### **Patent Layout**



- Patents authorized by the group: 4498 patents
- Patents for integrated circuits and chips: 778 patents
- Professional patent engineers and lawyers team
- Cooperative patent lawyers in Europe/USA/Japan









Professional patent engineer & patent lawyer team



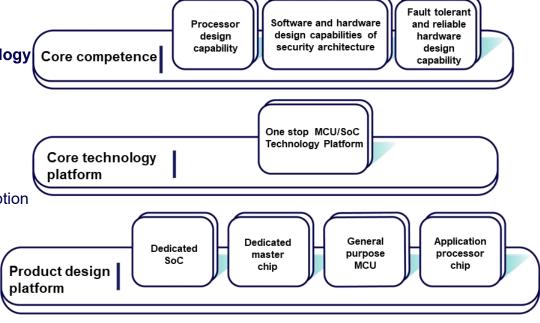
Patent risk control ecosystem

# **One-stop SoC Technology Platform**



Can be realized according to customer demand customized one-stop (including CPU instruction set custom) SoC chip design, supports self-controlled domestic CPU core.

- Diversified CPU core design technology
- ARM/T-head / RISC-V/Independent core
- Multi-core heterogeneous SoC design technology
- Provide dual-core to seven-core SoC chip design
- Low power, high integration, high security
- Security and encryption embedded eSE chip design technology
- 20 years of practical experience in security encryption
- Embedded-hardware level security protection
- Hybrid architecture chip design technology
- Hybrid ARM core of C-SKY
- C-SKY hybrid RISC-V core





## **Technical Capability Based on Three CPU Cores**

- General-purpose MCU technology capability based on ARM CPU
- Based on ARM Cortex-M0+, M3, M4, M7 cores
- Covering 66% of IoT applications, power consumption is less than 1uA,
   and central frequency is up to 1GHz
- SoC-eSE chip technology capability based on C-SKY CPU
- Based on C-SKY CK802, CK803, CK810, CK860 cores
- Obtained National Encryption Level 2, covering 100% of industrial IoT and innovative energy applications
- Technology Capability based on RISC-V CPU
- Geehy independently developed RISC-V core SC-20, SC-30, SC-70, SC-E5, SC-E7
- Can fully replace the ARM Cortex M core and partly replace the ARM Cortex-A series core



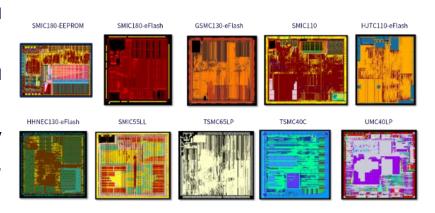
### **Soc Design Service Platform**





#### ◆ Provide customer SoC one-stop solution

- Reduce risks: deliver technical solutions on time and batch production
- Flexible business model: providing wafer fabrication and packaging services for customer GDS input projects
- Perfect supply chain/production management/quality control system: wafer fabrication, assembly, packaging, detection, final inspection and logistics
- Tape out >80 SoC project, process: 28~180nm



### World Class Upstream and Downstream Supply Chain



First class development partner & top supply chain to ensure high quality ecology

- Failure analysis: MATEK, Fibtek, CELLIX, iST
- IP supply chain: IPGoal, Synopsys, ACTT
- **Development tool**: Synopsys, Cadence
- Wafer: TSMC, SMIC, UMC, Huahong, Powerchip
- Close-test: JCET, HT-Tech, TFME, Ganide
- **Test**: ProbeLogic, ABLE, Teradyne, Chroma, Verigy









We always pursue excellent product quality.

Strictly control every detail in the production process

This is Jihai's eternal commitment to customers.

## **National Laboratory**

### Geehy

#### National Laboratory Certification

- Five laboratories: Testing, Failure Analysis,
   Reliability, Electricity, Application
- Approved by national CNAS laboratory in 2019

#### ■ International testing equipment

- Focused ion beam system, CP testing machine 3D X-ray
- Scanning electron microscope equipment, Tokyo precision probe, gold wire binding machine

















# **Reliability Assurance Platform**



- The national CNAS laboratory covers over 2100m²
- The total value of advanced inspection and testing instruments is nearly 100 million yuan
- Support complete reliability project testing
- The product has passed IEC61508 and USB-IF certification
- The reliability test scheme can be customized according to customer requirements



Reliability test items	Reference standard
HTOL	JESD22-A108
HTST	JESD22-A103
Precondition (For THT, uHAST, PCT, TCT)	JESD22-A113
THT	JESD22-A101
uHAST	JESD22-A110
PCT	JESD22-A102
TCT	ESD22-A104
DR	MIL-STD-883E Method 1008.2
ETC	MIL-STD-883E Method 1033
ST	JESD22-A102
НВМ	JESD22-A114
MM	JESD22-A115
CDM	JESD22-C101
Latch up	MIL-STD-78
EMC	EN 61000

## **First Class Operation Resources**



#### From technology introduction to innovation complementation



Establish cooperative relationship with famous universities and scientific research institutions

#### Union Institute

- Establish joint laboratory of "VLSI" with Zhejiang University
- Establish "Institute of Integrated Circuit Design and Application " with Zhengzhou University
- Establish Zhuhai R&D Center with the Embedded System Ministry of Education Engineering Research Center
- Establish "Lanzhou University-Apexmic customized class" with Lanzhou University

#### Scientific research activities

We have carried out scientific research activities with Zhejiang University, Tsinghua University, Zhengzhou University, Xidian University, and Shanghai Institute of Microsystem and Information Technology.

#### National Science and technology project

Jointly undertake national science and technology projects with Dalian University of Technology, Wuhan University, Zhejiang University and Beijing Institute of Technology of Zhuhai College.

### Strive To Realize Self Control Of Domestic Products

闭幕招待晚宴



- 2016, domestic printers SoC won "First prize of science and technology of China Electronic Society"
- 2018, CEO Mr Wang Dongjie won ICCAD entrepreneur of the Year Award
- 2019, 32-bit CPU security chip won "Second prize of Guangdong Province Science and technology progress"
- 2020, won "First Class Winner of China Hengqin Science and Technology Innovation Competition" (The bonus is RMB 50 million)
- SoC chip supplier with the largest volume of CPU shipments (cumulative over 500 million)
- Accumulate 8 times won the award of CSIP of MIIT and China Electronics"China core best market performance Product Award"





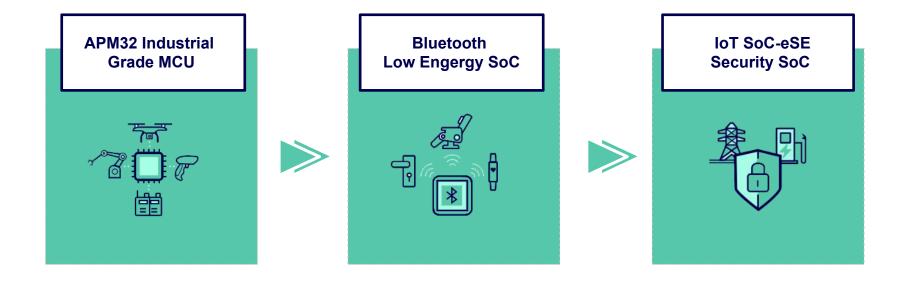






# **Product Layout**





## APM32: Focusing Long-life Cycle Domain













#### ■ Challenges of long life cycle products

- Needs more than 10 years' life, and chips need to undergo rigorous testing
- Design and manufacturing require higher performance
- Calibration and testing require higher precision
- Temperature range needs to be enhanced and impact resistant.

Geehy APM32 series of general MCU has covered industries, consumption and medical equipment. In 2020, it formally laid out automotive electronics and other fields.

#### ■ APM32 series of product

- IEC61508 and UCB-IF certification
- Temperature range is 40 °C ~ + 105 °C
- ESD level up to 8KV



## 32-bit Industrial Grade General Purpose MCU



APM32 series industrial-grade general-purpose MCU is highly compatible, highly accepted by customers, and low cost of domestic replacement.

- Based on ARM® Cortex®-M0+/M3/M4/M7 cores
- Low power, high performance, high integration, stable and reliable, fast replacement
- Has passed IEC61508 and USB-IF certification
- Working temperature covers -40°C ~+105°C
- ESD>8KV, adapt to demanding work environment requirements
- The whole life cycle quality control, product consistency is high, reliability is stable











Industrial Control



Medical Equipment



Automotive Electronic

### Roadmap of 2019-2020 MCU



APM32F051x8

M0+, 48MHz Flash:32-64KB SRAM:8KB APM32F072xB

M0+, 48MHz Flash:16/32KB SRAM:2/4KB Wireless series

Entry-level

Mainstream level

2020

APM32F030x8

M0+, 48MHz Flash:32-64KB SRAM:4-8KB APM32F071xB

M0+, 48MHz Flash:128KB SRAM:16KB

APM32F003x6

M0+, 48MHz Flash:16/32KB SRAM:2/4KB APM32F070xB

M0+, 48MHz Flash:128KB SRAM:16KB APM32F103xE

M3, 96MHz Flash:512KB SRAM:64/128KB

2019

**GW8811** 

M0, 64MHz Flash:512KB SRAM:24/32KB APM32F101xB

M3, 36MHz Flash:16-128KB SRAM:6-20KB APM32F102xB

M3, 48MHz Flash:16-128KB SRAM:6-20KB APM32F103xB

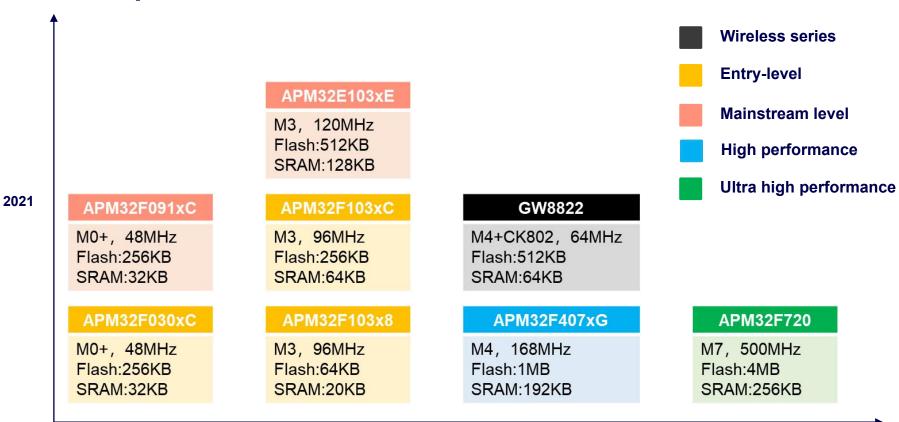
M3, 96MHz Flash:16-128KB SRAM:6-20KB

ARM® Cortex® -M0+/M0

ARM® Cortex® -M3

### Roadmap of 2021 MCU





## **Bluetooth 5.1 Low Engergy SoC**



Ultra-low power consumption, high sensitivity and comprehensive connectivity effectively guarantee the stability and security of IoT data transmission and communication connection

- Based on ARM® Cortex® -M4
- Support complete BLE5.1 specification,
- Support AOA/AOD accurate positioning function
- Support BLE,MESH,OTA and other PROFILE
- Excellent radio frequency characteristics and anti-interference performance
- Compliance with National Encryption Level 2









Smart Wear



Medical Equipment



Location Service



HID Device

# Dachuan Industrial Internet SoC-eSE Security Chip



The whole series of products is based on the T-head CPU core, rated as international advanced and domestic leading by experts.

- Based on T-head CPU multi-core security encryption architecture, integrated with advanced physical non-cloning technology and more than 30 anti-attack patent designs, it has obtained National Encryption Level 2
- Industry-leading embedded eSE security unit technology enables a single chip to have security and master control functions simultaneously, which can realize multi-in-one security protection and effectively resist the security threats of the IoT such as side-channel attacks, error injection and physical attacks
- It has been widely used in intelligent energy, high-end industry, numerical control devices and other essential security fields and industrial control core equipment
- In the future, it will expand to more important industries with an urgent demand for independent control, such as energy, transportation, nuclear power, communication, finance, etc





Industrial Control



Intelligent Building



AMI System



SCADA System



Smart Energy

# **Industrial Application**



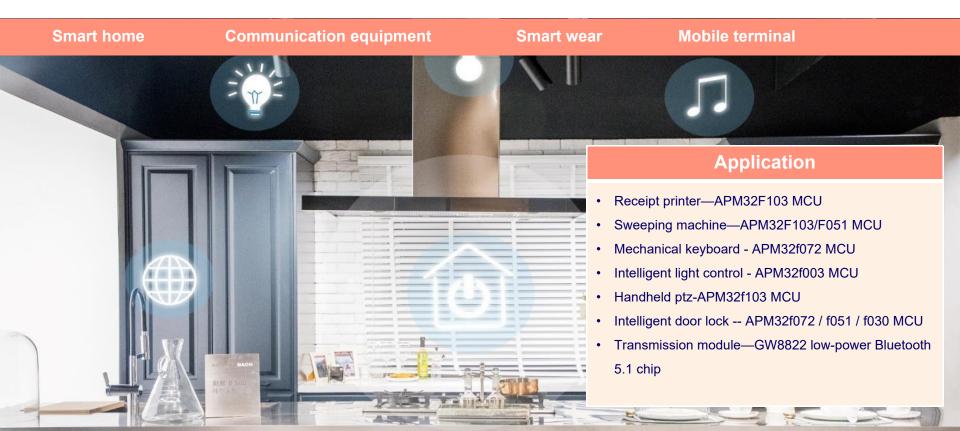
### Promote industry 4.0 technology and service landing



### **Consumer Electronics**



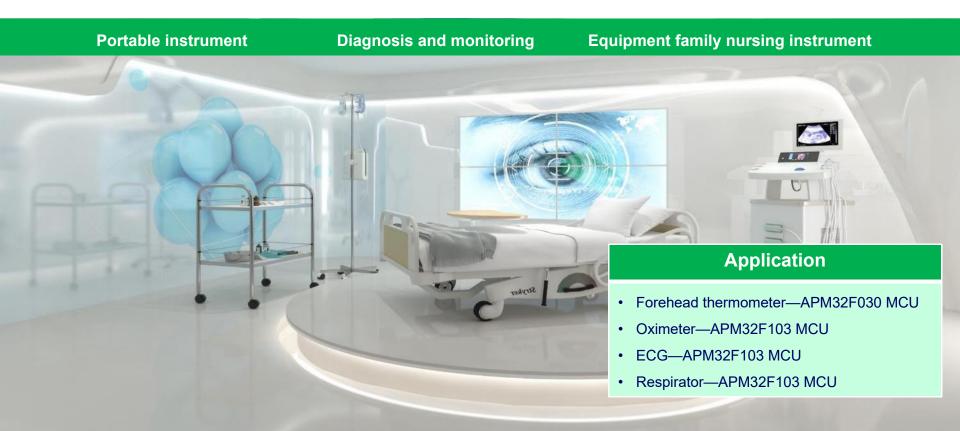
### Intelligent manufacturing creates higher quality life



# **Medical Equipment**



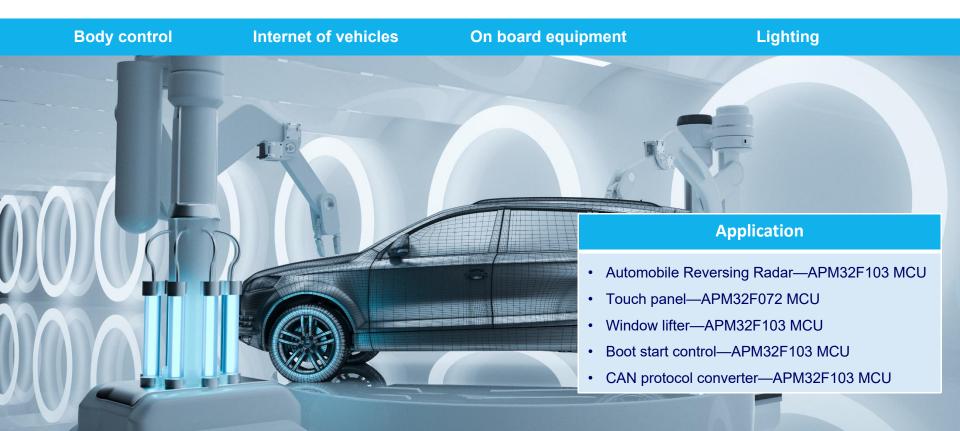
### Application innovation of enabling portable medical equipment



### **Automotive electronics**



### Accelerating the development and innovation of intelligent driving core



# **Service System and Mechanism**



Timely response to customer feedback to effectively solve customer needs.



#### ■ Sales and FAE localization support

- Professional sales and FAE team, provide localization service support
- There are offices in Shanghai, Shenzhen and Guangzhou
- Perfect service system and mechanism



Brand marketing Comprehensive promotion

#### ■ Brand marketing support

- Media channels: electronic fancier, Aspencore, big bit, EEPW,
- Regular participation in highly renowned and influential industry exhibitions and forums.
- The industry association's quality member units: China semiconductor industry, CCIAIOT, RISC-V, Bluetooth technology alliance, Information security and communication secrecy, and IoT Association.





### **Future Trend of The Industry**



#### Industry development: bring unprecedented demand











### **Ten Year Strategic Plan**



2029

2024

Become internationally renowned chip design enterprise

Become Chinese first class chip design enterprise







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